# The RF Sub-Micron MOSFET Line RF Power Field Effect Transistor Array

#### N-Channel Enhancement-Mode Lateral MOSFET

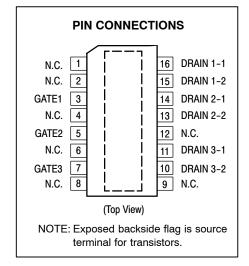
Designed for broadband commercial and industrial applications with frequencies to 1.0 GHz. The high gain and broadband performance of this device make it ideal for large-signal, common-source amplifier applications in 26 volt base station equipment. The device is in a PFP-16 Power Flat Pack package which gives excellent thermal performances through a solderable backside contact.

- Typical Performance at 960 MHz, 26 Volts
   Output Power 2 Watts Per Transistor
   Power Gain 18 dB
   Efficiency 50%
- Designed for Maximum Gain and Insertion Phase Flatness
- Capable of Handling 10:1 VSWR, @ 26 Vdc, 960 MHz, 2 Watts CW Output Power
- Excellent Thermal Stability
- Characterized with Series Equivalent Large-Signal Impedance Parameters
- In Tape and Reel. R2 Suffix = 1,500 Units per 16 mm, 13 inch Reel.

#### MRF9002R2

1.0 GHz, 2 W, 26 V LATERAL N-CHANNEL BROADBAND RF POWER MOSFET





#### **MAXIMUM RATINGS**

Rating	Symbol	Value	Unit
Drain-Source Voltage	V <sub>DSS</sub>	65	Vdc
Gate-Source Voltage	V <sub>GS</sub>	- 0.5, +15	Vdc
Total Dissipation Per Transistor @ T <sub>C</sub> = 25°C	P <sub>D</sub>	4	Watts
Storage Temperature Range		- 65 to +150	°C
Operating Junction Temperature	TJ	150	°C

#### THERMAL CHARACTERISTICS

Characteristic	Symbol	Value	Unit
Thermal Resistance, Junction to Case, Single Transistor	$R_{ heta JC}$	12	°C/W

NOTE - <u>CAUTION</u> - MOS devices are susceptible to damage from electrostatic charge. Reasonable precautions in handling and packaging MOS devices should be observed.

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#### **MOISTURE SENSITIVITY LEVEL**

Test Methodology	Rating	
Per JESD 22-A113	3	

#### **ELECTRICAL CHARACTERISTICS** ( $T_C = 25^{\circ}C$ unless otherwise noted)

Characteristic	Symbol	Min	Тур	Max	Unit
ON CHARACTERISTICS					
Gate Threshold Voltage $(V_{DS}=10\ Vdc,\ I_D=20\ \mu Adc)$	V <sub>GS(th)</sub>	2.4	_	4	Vdc
Gate Quiescent Voltage (V <sub>DS</sub> = 26 Vdc, I <sub>D</sub> = 25 mAdc)	V <sub>GS(Q)</sub>	3	_	5	Vdc
Drain-Source On-Voltage (V <sub>GS</sub> = 10 Vdc, I <sub>D</sub> = 0.1 Adc)	V <sub>DS(on)</sub>	_	0.3	_	Vdc

#### FUNCTIONAL TESTS (Per Transistor in Motorola Test Fixture, 50 ohm system)

Common-Source Amplifier Power Gain @ P1dB (V <sub>DD</sub> = 26 Vdc, I <sub>DQ</sub> = 25 mA, f = 960.0 MHz)	G <sub>ps</sub>	15	18	_	dB
Drain Efficiency @ P1dB (V <sub>DD</sub> = 26 Vdc, I <sub>DQ</sub> = 25 mA, f = 960.0 MHz)	η	35	50	_	%
Input Return Loss @ P1dB (V <sub>DD</sub> = 26 Vdc, I <sub>DQ</sub> = 25 mA, f = 960.0 MHz)	IRL	_	- 15	- 9	dB
Power Output, 1 dB Compression Point (V <sub>DD</sub> = 26 Vdc, I <sub>DQ</sub> = 25 mA, f = 960.0 MHz)	P <sub>1dB</sub>	34	37	=	dBm
Output Mismatch Stress (V <sub>DD</sub> = 26 Vdc, P <sub>out</sub> = 2 W CW, I <sub>DQ</sub> = 25 mA, f = 960.0 MHz, VSWR = 10:1, All Phase Angles at Frequency of Tests)	Ψ	No Degradation In Output Power			

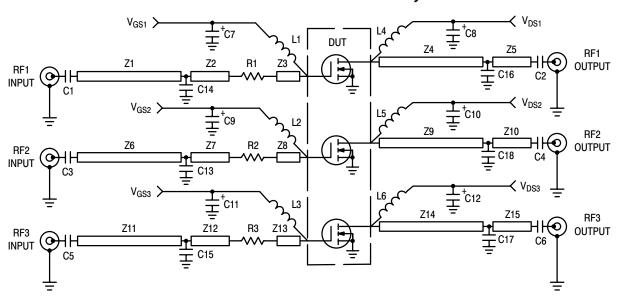


Figure 1. MRF9002R2 Broadband Test Circuit Schematic

Table 1. MRF9002R2 Broadband Test Circuit Component Designations and Values

Designators	Description
C1-C6	33 pF Chip Capacitors (0805)
C7-C12	1.0 μF, 35 V Tantalum Capacitors, B Case, Kemet
C13	8.2 pF Chip Capacitor (0805)
C14, C15	10 pF Chip Capacitors (0805)
C16, C17	2.7 pF Chip Capacitors (0805)
C18	3.3 pF Chip Capacitor (0805)
L1-L6	12 nH Chip Inductors (0805)
R1-R3	0 Ω Chip Resistors (0805)
Z1, Z11	1.16 x 28.5 mm Microstrip
Z2, Z7, Z12	0.65 x 5.6 mm Microstrip
Z3, Z8, Z13	0.65 x 2.6 mm Microstrip
Z4, Z14	1.16 x 19.5 mm Microstrip
Z5, Z15	1.16 x 17.5 mm Microstrip
Z6	1.16 x 12.9 mm Microstrip
Z9	1.16 x 27.2 mm Microstrip
Z10	1.16 x 4.3 mm Microstrip
PCB	Etched Circuit Board
Raw PCB Material	Rogers RO4350, 0.020", 2.5", x 2.5", ε <sub>r</sub> = 3.5
Bedstead	Copper Heatsink

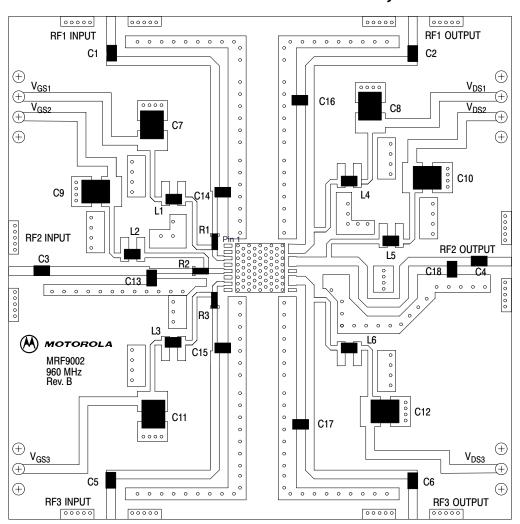


Figure 2. MRF9002R2 Broadband Test Circuit Component Layout

#### **TYPICAL CHARACTERISTICS**

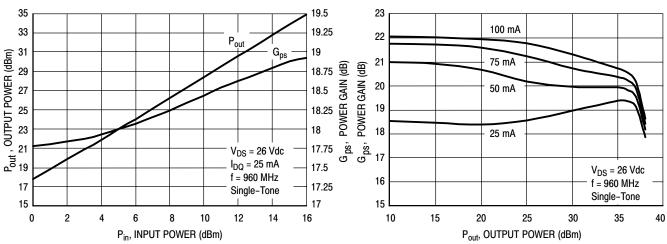


Figure 3. Output Power and Power Gain versus Input Power

Figure 4. Power Gain versus Output Power

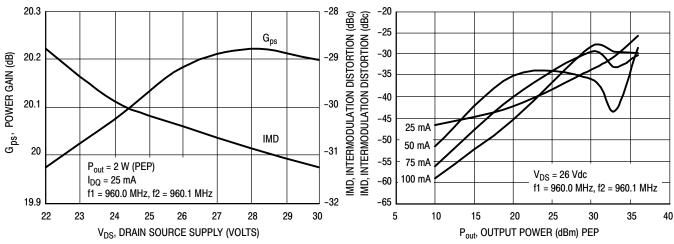


Figure 5. Power Gain and Intermodulation Distortion versus Supply Voltage

Figure 6. Intermodulation Distortion versus Output Power

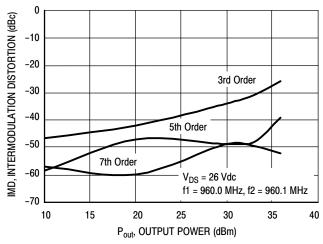


Figure 7. Intermodulation Distortion Products versus Output Power

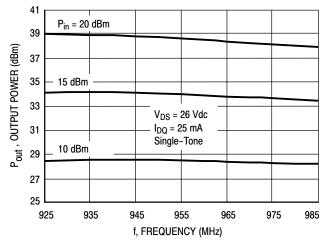


Figure 8. Output Power versus Frequency

#### **TYPICAL CHARACTERISTICS**

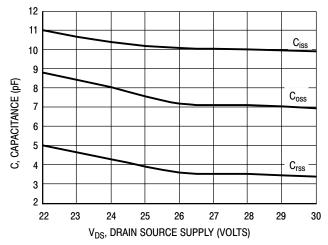
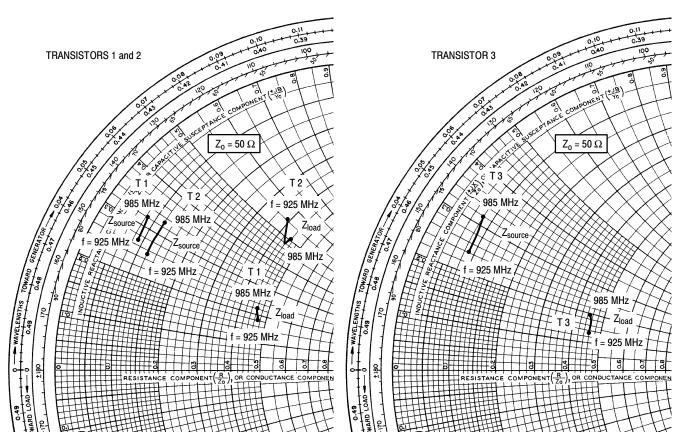


Figure 9. Capacitance versus Drain Source Voltage



 $V_{DD}$  = 26 V,  $I_{DQ}$  = 25 mA,  $P_{out}$  = 2 W PEP

f MHz	$\mathbf{Z_{source}}_{\Omega}$	$oldsymbol{Z_{load}}{\Omega}$
925	4.5 + j13.3	23.4 + j9.2
960	4.3 + j15.3	23.2 + j10.4
985	4.1 + j15.8	23.0 + j11.1

Transistor 1

 $V_{DD}$  = 26 V,  $I_{DQ}$  = 25 mA,  $P_{out}$  = 2 W PEP

f MHz	$\mathbf{Z_{source}}_{\Omega}$	$oldsymbol{Z_{load}}{\Omega}$
925	6.0 + j12.3	19.7 + j27.8
960	5.9 + j14.3	22.0 + j23.9
985	5.8 + j16.5	22.5 + j25.4

Transistor 2

 $V_{DD}$  = 26 V,  $I_{DQ}$  = 25 mA,  $P_{out}$  = 2 W PEP

- DL	,,-DQ,-,-(	Jul —
f MHz	$oldsymbol{Z_{source}}_{\Omega}$	$oldsymbol{Z_{load}}{\Omega}$
925	4.3 + j12.2	23.1 + j6.5
960	4.3 + j14.0	22.8 + j8.4
985	3.9 + j15.9	22.6 + j9.3

**Transistor 3** 

 $Z_{source} \ = \ Test \ circuit \ impedance \ as \ measured \ from \\ gate \ to \ ground.$ 

Z<sub>load</sub> = Test circuit impedance as measured from drain to ground.

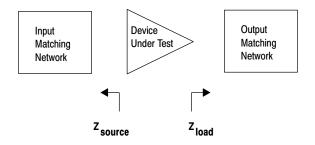
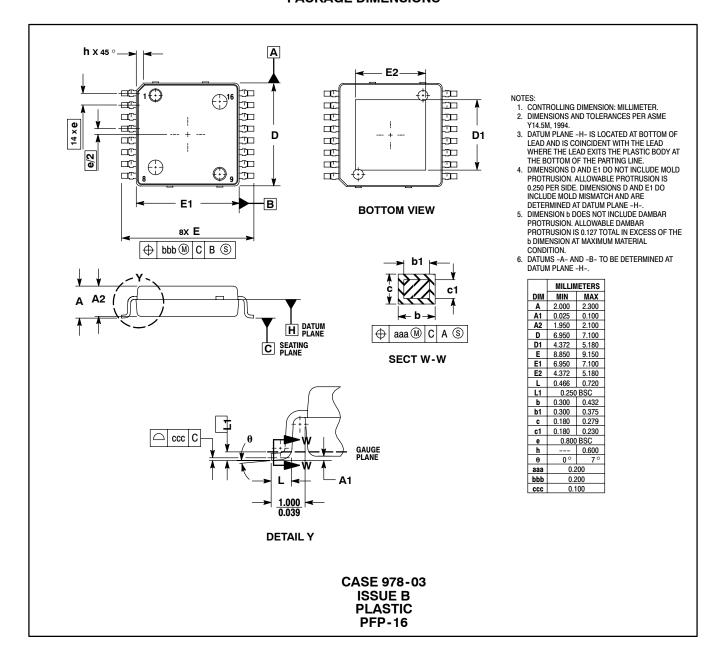


Figure 10. Series Equivalent Source and Load Impedance

#### **PACKAGE DIMENSIONS**



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